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Special issue on SoC and AI processors

Artificial Intelligence (AI) has evolved into a general technology for a wide range of purposes and has been applied in all aspects of economy and society. It has already been extensively used in various fields, including medical services, finance, security, education, transportation, and logistics, and had led to the emergence of new commercial activities, business models, and game-changing product applications. AI is a driving force to economic and social development at the forefront of the technological revolution and industrial transformation. Additionally, System-on-a-Chip (SoC) plays a vital role in post-PC era products like smartphones, tablets, and various wearable devices where form-factor, cost, and energy-efficiency, are critical drivers. It contains multiple processing parts such as the central processing unit (CPU), graphics processing unit (GPU), image processing unit (IPU), digital signal processor (DSP), video encoder/decoder, modems, and neural processing unit (NPU). Specifically, AI processors, another name for NPU, are specially optimized for mathematics and algorithms commonly used by neural networks. They can run neural networks and machine learning tasks faster and more efficiently than CPUs.

In this special issue, we have selected papers that represent the current state-of-the-art in AI processors as well as in essential SoC blocks used in radar, RF/analog, hardware security, and design methodology.

The first paper "40TFLOPS Artificial Intelligence Processor with Function-safe Programmable Many-Cores for ISO26262 ASIL-D" by Jinho Han et al. presents AI processor architecture that has high throughput for accelerating the neural network and reducing the required external memory bandwidth for processing the neural network. For high throughput, the proposed super thread core (STC) includes 128×128 nano cores operating at 1.2 GHz clock frequency and the general-purpose processor (GPP) core is integrated for the control of the STC and processing AI algorithm. For the functional safety that becomes very important in automotive systems, various microarchitectural techniques are adopted, including the self-recovering cache and dynamic lockstep (DLS) function, to achieve ASIL-D of ISO26262 standard fault tolerance levels. The entire AI processor fabricated in the 28-nm CMOS process yields peak performance

up to 40TFLOPS at 1.2 GHz operating frequency and 1.1 V supply voltage, with a measured energy efficiency of 1.3TOPS/W and ISO26262 ASIL-D compliant, single-point fault tolerance rate equal to 99.64%.

The next paper titled "An impulse radio (IR) radar SoC for through-the-wall human-detection applications" by Piljae Park et al. proposes through-the-wall radar (TTWR) SoC and its architecture with the test standards and methods, which can be used at disaster scenes in limited visibility conditions owing to smoke, walls, and collapse debris. Additive reception based on the coherent clocks and reconfigurability can fulfill the demands for the TTWR and a clock-based single-chip IR radar transceiver is implemented in 130-nm CMOS technology. By utilizing the repetitive coherent clock schemes, the proposed SoC can achieve signal-to-noise-ratio (SNR) enhancements. Furthermore, this paper shows the test results in various pseudo-disaster conditions of the hand-held prototype radar with the proposed TTWR SoC operating in real-time.

The third paper "AB9: a Neural Processor for Inference Acceleration" by Yong Cheol Peter Cho et al. presents a neural processor for interference acceleration with the systolic tensor core (STC) by exploiting data-reuse and parallelism characteristics inherent in neural networks, while also providing fast access to large on-chip memory. AB9 shows a superior performance and power efficiency to those of a general-purpose GPU (GPGPU) for YOLOv2, and has been fabricated with a 28-nm CMOS process along with a 40 TFLOP STC that includes 32 k arithmetic units and over 36 MB of on-chip SRAM.

To alleviate the high-computational and memory-intensive burdens in deep neural networks, the following paper "Automated Optimization for Memory-efficient High Performance Deep Neural Network Accelerators" by Hyun Mi Kim et al. investigates the efficient memory structure and operating scheme, which can provide an intuitive solution for high-performance accelerators along with dataflow control. The authors propose an efficient architecture with flexibility, while operating at high frequency despite the large memory size and PE array. They demonstrate an improvement in the efficiency and usability of the architecture by presenting

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an automation algorithm for optimization. The experiments show that the proposed architecture with the increased data reuse, such as a diagonal write path, improves the performance by 1.44× on average across a wide range of neural networks. The automated optimizations dramatically improve the performance from 3.8× to 14.79× that enhances usability even further.

Recently, the importance of security has emerged in various computing fields, such as mobile, biomedical, and automotive systems. The paper "An Analysis and Efficient Hardware Implementation of True Random Number Generator Based-on Beta Source" by Seongmo Park et al. proposes an efficient hardware random number generator based on a beta source. The proposed generator generates the values of "0" and "1" and provides a method to distinguish between pseudo-random and true random numbers by comparing them with simple cumulative operations. The random-number generator produces labeled data, thus indicating whether the count value is a true random number based on the bit values of the binary count value and on the comparison of the generated labeling data that are used as reference data. The generated random numbers pass the test procedures outlined in the standards SP800-22 and SP800-90B issued by the National Institute of Standards (NIST).

To improve design productivity in SoC, high-level synthesis (HLS) has become popular, and has been used to automatically synthesize a register-transfer level (RTL) circuit from a behavioral description written in a high-level programing language such as C/C++. However, HLS tools often generate the design with the larger area overhead owing to unnecessary redundant instances. In the paper entitled "Function-Level Module Sharing Techniques in High-Level Synthesis" by Hiroki Nishigawa et al., the authors present two HLS techniques for module sharing at function level and show the effectiveness with the experimental results.

The paper "Field Programmable Analog Arrays for Implementation of Generalized Balanced OTA-C Odd/ Even-nth-Order Elliptic Filters" by Maha Diab and Soliman Mahmoud presents an architecture for a field-programmable analog array based on operational transconductance amplifier (OTA) as the building block that can be used in analog signal processing units operating at low frequencies such as biopotential signals. The architecture eliminates the need for switches in the signal path and has a flexible structure. Moreover, this work presents a simplified direct circuit realization method for the synthesis of OTA-C even/odd-nth-order elliptic filters. The proposed method results in an OTA-C

symmetric balanced structure with a minimum number of components and grounded capacitors for a balanced design.

The final paper "W-band MMIC Chipset in 0.1 um mHEMT Technology" by Jong Min Lee et al. developed 0.1μm metamorphic high electron mobility transistor (mHEMT) and fabricated W-band monolithic microwave integrated circuit chipset with in-house technology to verify the performance and usability of the developed technology. The direct current (DC) characteristics of mHEMT include a drain current density equal to 747 mA/mm and a maximum transconductance of 1.354 S/mm. In addition, the RF characteristics include a cut-off frequency of 210 GHz and maximum oscillation frequency of 252 GHz. To increase the frequency of an input signal, a frequency multiplier is developed that consists of three common source doublers connected in cascade. The authors also present in this paper a low-noise amplifier with a four-stage, single-ended architecture with a common source stage and a W-band IR module with an external offchip coupler.

The Guest Editors thank all the authors, reviewers, and the editorial staff members of the ETRI Journal for making this special issue a success. We are most pleased to have been part of this effort, and for the timely publication of these high-quality technical articles.

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